



# **CMI563®**

Advanced surface copper measurement on single, double-sided, or multi-layer PCB



# MICRORESISTANCE TECHNOLOGY FOR ACCURATE MEASUREMENT OF SURFACE COPPER

The CMI563® provides advanced technology for accurate measurement on copper plating and it ensures that the opposite side of the PCB will not interfere with readings, regardless of laminate thickness. Our CMI563® makes it simple to obtain precise surface copper measurement on laminate, electroless, or electrolytic copper. This gauge is an ideally suited for:

- PCB manufacturing and assembly.
- Copper surface thickness.

Our CMI563® provides superior performance for copper foil measurement on flexible or rigid, single, double-sided, or multi-layer boards.

### **SRP-4 PROBE**

Included standard with the CMI563® gauge is a tethered SRP-4 probe with user-replaceable tips. This patented probe design consists of four pins securely encased for durability. Its see-through casing allows for easy placement. The tethered cable is ideal for field applications, and it has a small footprint for convenience.

## MICRORESISTANCE TECHNOLOGY

Microresistance makes the CMI563® highly accurate for electroless and electrodeposited copper applications, and even works on fine trace measurements. It uses four-point contact to generate an electrical signal. A current is passed between the outer pins, and voltage drop is measured between the inner pins of the sample.

#### **KEY FEATURES:**

- Advanced microsistance technology.
- Factory calibrated
- Highly accurate copper thickness measurement.

ADVANCED
MICRORESISTANCE
TECHNOLOGY

## SRP-4 USER REPLACABLE PROBE TIPS (PATENT 7,148,712)

- Easily replace a broken probe tip.
- Optional NIST-traceable check standards to match a variety of thickness ranges.
- One replacement probe standard, additional probe tips available (packages of 3).

#### **SPECIFICATIONS**

- Accuracy: ±1% (±0.1 μm).
- Precision: Electroless Cu: 0.2% typical.

  Electrodeposited Cu: 0.5% typical.
- Resolution: mil: 0.01 at > 1, 0.001 at < 1.
  - $\mu$ m: 0.1 at > 10, 0.01 at < 10, 0.001 at < 1.
- Fine Line Measure: Trace width 8 to 250 mil (203–6350 μm).
- Dimensions: in: 5 7/8 (L) x 3 1/8 (W) x 1 3/16 (D). cm: 14.9 (L) x 7.94 (W) x 3.02 (D).

- Memory Capacity: 13,500 readings.
- Weight: 9 oz (0.26 kg).
- Battery: 9V Alkaline (65 hrs.).
- LCD Display: Four-digit, two-digit memory, 1/2" (1.27 cm) character height.
- Statistical Display: Readings, standard deviation, mean, high/low.

#### **PCB & COPPER COMPARISON CHART**

We offer multiple choices for a PCB gauge within the PCB industry to provide you with the best and most cost-effective solution available for your application needs. Please reference the comparison chart below or contact us at **contact@hitachi-hightech.com** for our expert advice.

	CMI95M	CMI165	CMI511	CMI563	CMI760
Technique	Microresistance	Microresistance	Eddy	Microresistance	Microresistance
Copper Foil	•	•		•	•
Copper Laminate	•	•		•	•
Copper - Surface		•		•	•
Copper – Fine Line		•		•	•
Copper Thru-hole			•		Optional
Temperature Compensation		•	•		ETP Probe
Replacement Probe Tip		•		•	SRP-4 Probe
Unit Selection	oz or µm	mil or µm	mil or µm	mil or µm	mil or µm
Copper Thickness Range					
μm	8 indicator lights: 5-140	Electroless: 0.25-12.7 Electroplated: 2-254	2-102	Electroless: 0.25-12.7 Electroplated: 0.25-152	Surface: 0.25-254 Thru-hole: 1-102
mil		Electroless: 0.01-0.5 Electroplated: 0.1-10	0.08-4.0	Electroless: 0.01-0.5 Electroplated: 0.01-6	Surface: 0.01-10 Thru-hole: 0.08-4

Our global network of service hubs offer a full range of technical support to keep you up and running. We are A2LA certified\* for coating thickness calibrations and standards which ensures that your CMI563® will be compliant at audit to ISO 17025.

\*A2LA accreditation is applicable to work performed by Hitachi High-Tech Analytical Science America, Inc.



If you'd like to learn more about the CMI563® gauge visit www.hitachi-hightech.com/hha or email one of our experts at contact@hitachi-hightech.com to book a demo.

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